

January 2014 Rev. 1.0.1

#### **GENERAL DESCRIPTION**

The XRP6274 is an ultra low dropout voltage regulator capable of delivering 2A output currents. It is unique in the industry in being able to operate from a single supply rail of 1.045V to 2.625V without the need for a noise generating charge pump.

With its ultra low dropout voltage of 140mV at full load guaranteed over temperature, the XRP6274 achieves conversions previously unavailable.

The output voltage can be set as low as 0.6V with  $\pm 0.5\%$  accuracy making the XRP6274 perfectly suited for powering low voltage devices such as FPGAs, DSPs, ASICs, and other SOCs.

Built-in current limit, reverse bias and thermal protection ensures safe operation under abnormal operating conditions. An enable function, soft start and Power Good flag complete the feature set.

The XRP6274 is offered in RoHS compliant, "green"/halogen free 10-pin 3x3mm DFN package.

#### **FEATURES**

- 2A Output Current
- 1.045V to 2.625V Single Input Voltage
  - Adjustable Output Voltage ≥0.6V
  - ±0.5% Output Voltage Accuracy
- Ultra Low Dropout Voltage
  - 140mV Max over temp @ 2A
- Power Good Flag
- Enable & Soft Start
- Current Limit and Thermal Protection
- Reverse Bias Protection
- RoHS compliant "Green"/Halogen Free
  - 10-pin 3mm x 3mm DFN

#### **APPLICATIONS**

- Point of Load Conversion
- Microprocessors, DSPs, FPGAs Supplies
- Networking & Telecom Equipment
- Switching Supplies Post Regulation

#### TYPICAL APPLICATION DIAGRAM

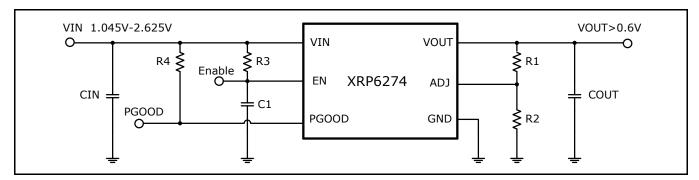


Fig. 1: XRP6274 Application Diagram



#### **ABSOLUTE MAXIMUM RATINGS**

These are stress ratings only and functional operation of the device at these ratings or above any other of those indicated in the operation sections of the specifications below is not implied. Exposure to absolute maximum rating conditions for extended periods of time may affect reliability.

| Input Voltage V <sub>IN</sub> , V <sub>PGOOD</sub> | 3V            |
|--|---------------|
| Enable Voltage V <sub>EN</sub>                     | VIN+0.5V≤3V   |
| Storage Temperature                                | 65°C to 150°C |
| Junction Temperature                               | 150°C         |
| Lead Temperature (Soldering, 5 sec)                | 260°C         |
| ESD Rating (HBM - Human Body Model)                |               |
| All pins   | 2kV           |

#### **OPERATING RATINGS**

| Input Voltage Range V <sub>IN</sub> , V <sub>EN</sub> , V <sub>PGOOD</sub> | 1.045V-2.625V |
|--|---------------|
| Junction Temperature Range   | 40°C to 125°C |
| Thermal Resistance $\Theta_{JA}$ DFN10                                     | 40.5°C/W      |

#### **ELECTRICAL SPECIFICATIONS**

Specifications are for an Operating Junction Temperature of  $T_J = T_A = 25^{\circ}\text{C}$  only; limits applying over the full Operating Junction Temperature range are denoted by a " $\bullet$ ". Typical values represent the most likely parametric norm at  $T_J = 25^{\circ}\text{C}$ , and are provided for reference purposes only. Unless otherwise indicated,  $V_{IN} = V_{OUT} + 0.5V$  and  $I_{OUT} = 20\text{mA}$ ,  $C_{IN} = 47\mu\text{F}$ ,  $C_{OUT} = 47\mu\text{F}$ ,  $T_A = 25^{\circ}\text{C}$ .

| Parameter  | Min.  | Тур.  | Max.  | Units                 |   | Conditions   |
|--|-------|-------|-------|-----------------------|---|--|
| Input Voltage Operating Range                            | 1.045 |       | 2.625 | V                     | • |  |
| Maximum Output Current <sup>1</sup>                      | 2     |       |       | Α                     |   |  |
| Ground Current   |       | 2.0   |       | mA                    |   | EN active  |
| Ground Current   |       | 2.5   | 6.0   | mA                    |   | EN active , I <sub>OUT</sub> =2                            |
| Shutdown Current   |       | 12    |       | μΑ                    |   | V <sub>EN</sub> =0V, I <sub>OUT</sub> =0mA, PGOOD Floating |
|  | 598.5 | 601.5 | 604.5 | mV                    |   | V <sub>IN</sub> =2.5V, V <sub>OUT</sub> >1V                |
|  | 594.0 |       | 606.0 | mV                    | • | VIN-2.3V, VOUT>1V  |
| ADJ Pin Voltage  | 597.0 | 600.0 | 603.0 | mV                    |   | V <sub>IN</sub> =1.8V                                      |
| 7.63 i iii Voitage                                       | 592.0 |       | 605.0 | mV                    | • | V IIV = 1.0 V  |
|  | 596.0 | 599.0 | 602.0 | mV                    |   | V <sub>IN</sub> =1.35V                                     |
|  | 590.7 |       | 604.0 | mV                    | • |  |
| Dropout Voltage  |       |       | 140   | mV                    | • | I <sub>OUT</sub> =2A, V <sub>OUT</sub> =1.0V (Note 2)      |
| Output Voltage Load<br>Regulation                        |       |       | 0.25  | %                     |   | $V_{IN}=V_{OUT}+0.5V$ , $20mA \le I_{OUT} \le 2A$          |
| Power Supply Rejection Ratio                             |       | 35    |       | dB                    |   | f=1kHz   |
| (PSRR)   |       | 30    |       | dB                    |   | f>300kHz   |
| Output Noise Voltage                                     |       | 200   |       | $\mu V_{\text{RMS}}$  |   | 10Hz-100kHz  |
| Current Limit  | 2.1   |       | 4.4   | Α                     | • | $V_{OUT} = 0.9 \times V_{OUT(NOM)}$                        |
| Reverse Bias Protection V <sub>OUT</sub> Leakage current |       | -10   |       | μA                    |   | V <sub>IN</sub> =0V, V <sub>OUT</sub> =2.625V              |
| Thermal Shutdown<br>Temperature                          |       | 160   |       | °C                    |   |  |
| Thermal Shutdown Hysteresis                              |       | 30    |       | °C                    |   |  |
| Start Up time  |       | 2     |       | ms                    |   | V <sub>OUT</sub> =1.0V                                     |
| Power Good Threshold                                     | 92    | 94    | 97    | % of V <sub>OUT</sub> | • | V <sub>OUT</sub> rising                                    |
| Power Good Threshold<br>Hysteresis                       |       | 2.8   |       | % of V <sub>OUT</sub> |   | V <sub>OUT</sub> falling                                   |
| DCCCCD Cutaut Law  |       |       | 0.4   | V                     | • | VIN>1.5V, I <sub>SINK</sub> =1mA                           |
| PGOOD Output Low   |       |       | 0.4   | V                     | • | VIN>1.045V, I <sub>SINK</sub> =100uA                       |



| Parameter                            | Min. | Тур. | Max.  | Units |   | Conditions   |
|--------------------------------------|------|------|-------|-------|---|--|
| <b>Enable Pin Specifications</b>     |      |      |       |       |   |  |
| Enable Threshold Voltage             | 0.43 | 0.55 | 0.67  | V     | • | V <sub>EN</sub> rising                                 |
| EN Sink Current                      |      | 2.5  |       | uA    |   | EN <v<sub>IN</v<sub>                                   |
| EN SIIK Current                      |      | 15   |       | uA    |   | $V_{IN}$ <en<<math>V_{IN}+0.5<math>V</math></en<<math> |
| Maximum Allowable EN Sink<br>Current |      |      | 100uA | uA    |   | EN=V <sub>IN</sub> +0.5V (when using internal clamp)   |
| EN Source Current                    |      |      | 10    | uA    |   | EN=0V  |

Note 1: The XRP6274 is rated over a junction temperature range  $T_J$  of -40°C to +125°C. For a given set of operating conditions,  $T_J$  has to be calculated in order to make sure it does not exceed maximum specification. Use equation  $T_J = T_A + (P_D.\Theta_{JA})$  where  $\Theta_{JA}$  is the package thermal impedance,  $T_A$  is the ambient temperature and  $P_D$  is power dissipation.  $P_D$  is calculated from  $P_D = (V_{IN} - V_{OUT}).I_{OUT}$ 

Note 2: Dropout voltage is defined as the input to output voltage differential ( $V_{IN}$  -  $V_{OUT}$ ) where the input voltage is low enough to cause the output voltage to drop 2% from the nominal value.

#### **BLOCK DIAGRAM**

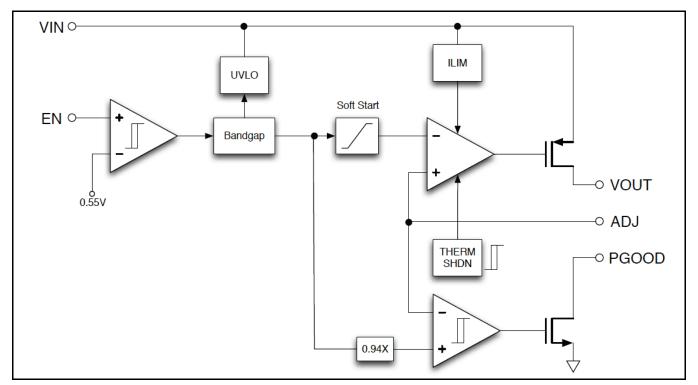


Fig. 2: XRP6274 Block Diagram



#### **PIN ASSIGNMENT**

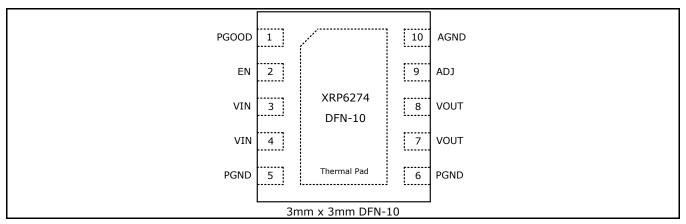


Fig. 3: XRP6274 Pin Assignment

## **PIN DESCRIPTION**

| Name      | PIN# | Description  |
|-----------|------|--|
| EN        | 2    | Enable Input Pin. This is a high impedance MOS input with CMOS logic level compatibility. Logic high enables the device; logic low disables the device. Do not pull this pin higher than VIN+0.5V. |
| VIN       | 3, 4 | Power Input Pin. Must be closely decoupled to PGND pin with a $4.7\mu\text{F}$ or greater ceramic capacitor.   |
| PGOOD     | 1    | Power Good open Drain Output. When used it should be pulled up to VIN with a resistor. Typical resistor value 100k.  |
| VOUT      | 7, 8 | Regulator Output pin. Must be closely decoupled to PGND pin with a $4.7\mu F$ or greater ceramic capacitor.  |
| ADJ       | 9    | Adjustable Pin. Connect to a resistive voltage divider to set the output voltage of the device.  |
| PGND      | 5, 6 | Power Ground   |
| Ther. Pad |      | Connect to PGND.   |
| AGND      | 10   | Signal ground. Connect with a separate trace to the ground of the output being regulated.  |

## **ORDERING INFORMATION**

| Part Number    | Junction<br>Temperature<br>Range | Marking | Package    | Packing<br>Quantity | Note 1       | Note 2             |
|----------------|----------------------------------|---------|------------|---------------------|--------------|--------------------|
| XRP6274EH-F    |                                  | 6274E   |            | Bulk                |              | 2 4                |
| XRP6274EHMTR-F | -40°C≤T <sub>J</sub> ≤+125°C     | YYWW    | 10-pin DFN | 250/Tape & Reel     | Halogen Free | 3Amp<br>Adjustable |
| XRP6274EHTR-F  |                                  | XXXXX   |            | 3K/Tape & Reel      |              | Adjustable         |
| XRP6274EVB     | XRP6274 Evaluation board         |         |            |                     |              |                    |

<sup>&</sup>quot;YY" = Year - "WW" = Work Week - "X" = Lot Number when applicable.

#### TYPICAL PERFORMANCE CHARACTERISTICS

All data taken at  $V_{IN} = V_{OUT} + 0.5V$ ,  $T_J = T_A = 25$ °C, unless otherwise specified - Schematic and BOM from Application Information section of this datasheet.

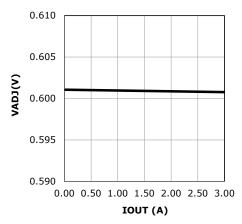


Fig. 4: VADJ versus IOUT, 1.5VIN, 1VOUT

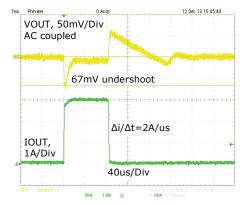


Fig. 6: Transient response, 20mA-3A, 1.5VIN, 1VOUT

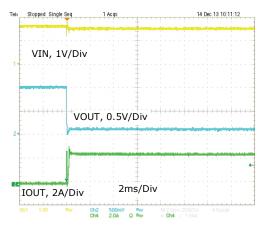


Fig. 5: Short-circuit, 1.5VIN, 1VOUT

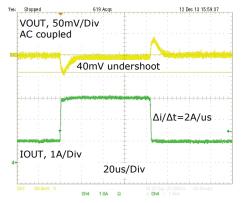


Fig. 7: Transient response, 1A-3A, 1.5VIN, 1VOUT

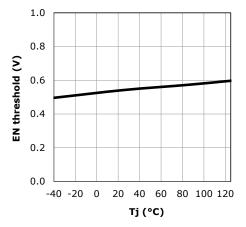


Fig. 8: Enable threshold versus temperature



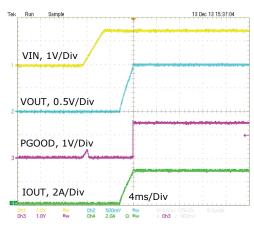


Fig. 9:Powerup, IOUT=3A, 1.5VIN, 1VOUT

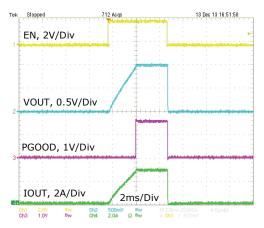


Fig. 11: Enable turn on/off, 3A, 1.5VIN, 1VOUT

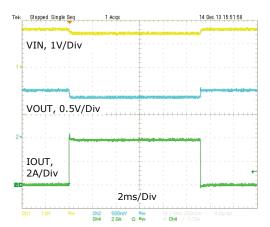


Fig. 13: Current limit, 1.5VIN, 1VOUT

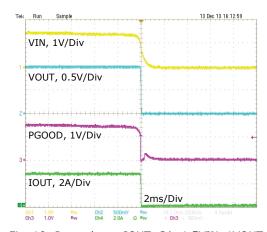


Fig. 10: Powerdown, IOUT=3A, 1.5VIN, 1VOUT

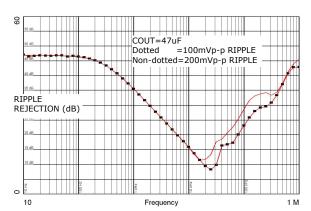


Fig. 12: PSRR, 50mA, 1.5VIN, 1VOUT, 47uF COUT

#### THEORY OF OPERATION

#### SINGLE RAIL INPUT VOLTAGE

The XRP6274's ultra low input voltage allows single rail operation from 2.625V down to 1.045V without requiring any extra biasing voltage. This single input voltage range provides easy conversions from industry standard 1.1V, 1.2V, 1.35V, 1.5V, 1.8V and 2.5V power rails.

#### **DROPOUT VOLTAGE**

The dropout voltage is the input-to-output differential voltage at which the XR6275 ceases to regulate against further reductions in input voltage; this point occurs when the input voltage approaches the output voltage. The XRP6274 provides ultra low industry leading dropout voltage performance making it the perfect solution for high current extremely tight input/output voltage conversions. This extremely low dropout voltage allows high efficiencies conversions.

Below tables illustrate the achievable conversions for different load requirements for the XRP6274.

| 2A      | Output Voltage |      |      |      |      |      |      |      |      |
|---------|----------------|------|------|------|------|------|------|------|------|
| VIN (V) | 1.80           | 1.50 | 1.35 | 1.20 | 1.10 | 1.00 | 0.90 | 0.80 | 0.60 |
| 2.50    | Yes            | Yes  | Yes  | Yes  | Yes  | Yes  | Yes  | Yes  | Yes  |
| 1.80    |                | Yes  |
| 1.50    |                |      | No   | Yes  | Yes  | Yes  | Yes  | Yes  | Yes  |
| 1.35    |                |      |      | No   | Yes  | Yes  | Yes  | Yes  | Yes  |
| 1.20    |                |      |      |      | No   | Yes  | Yes  | Yes  | Yes  |
| 1.10    |                |      |      |      |      | No   | Yes  | Yes  | Yes  |

Note: Yellow indicates conversions that may be thermally limited

The maximum output current available for a given conversion is dependent on the operating conditions and thermal performance of DFN10/PCB (see note 1 on page 3).

#### **SETTING THE OUTPUT VOLTAGE**

The XRP6274 is an adjustable regulator that can be programmed to any value between 0.6V and 2.4V using 2 external resistors, R1 and R2. The relationship between the resistors and the output voltage is:

$$R_1 = R_2 \times \left(\frac{V_{OUT}}{0.6} - 1\right)$$

where  $V_{OUT}$  is the desired output voltage.

Sum of resistors R1 and R2 must meet the following requirement:

$$\frac{V_{OUT}}{R1 + R2} \ge 20mA$$

#### **INPUT AND OUTPUT CAPACITORS**

The XRP6274 is designed to be stable for all available types and values of output capacitors greater than  $4.7\mu F$ .

The required capacitance on the  $V_{IN}$  and  $V_{OUT}$  pins strongly depends on the input supply source impedance; the minimum recommended capacitor for VIN is 4.7 $\mu$ F. Low ESR ceramic X5R and X7R capacitors are recommended and should be placed as close as possible to the pins for optimal performance.

Because of the low voltages and high currents supported by this device, typical values of 47uF for both input and output capacitors are recommended when powering high speed digital circuits.

#### **ENABLE INPUT AND SHUTDOWN**

The enable pin (EN) can be used to shut down the XRP6274. Connecting this pin to ground signal or to a voltage less than typical 0.55V will completely turn off the regulator.

The enable pin is a high impedance MOS input. In order to allow the EN pin compatibility with 5V or 3.3V control signals, there is an internal clamp set to VIN+0.5V. When using the EN pin with a control signal greater than VIN+0.5V, a resistor must be placed in series with the EN pin to limit the input current below 100uA. The resistor must also be low enough to ensure at least 15uA can be sourced to enable the part.

The precision feature enables simple sequencing of multiple power supplies with a resistor divider from another power supply or power good flag. The EN pin can also be used as an external UVLO to disable the part when input voltage falls below a lower boundary of operation.

When enable control is not required, the EN pin should be connected to VIN through an RC in order to delay the EN function until the



input voltage reaches 1.045V. This ensures clean sequencing of the internal circuitry.

#### **SOFT START**

The XRP6274 features a soft-start which controls the output voltage ramp and allows the regulator to gradually reach the initial steady state operating point. This reduces current spikes and surges at start up due to output capacitor inrush current. Internal sequencing completes in 50us, and then the reference voltage is linearly ramped over a period of approximately 2ms.

The inrush current will be the lesser of the current limit value or the current defined by the equation below:

$$I_{INRUSH} = C_{OUT} \frac{V_{OUT}}{2000us}$$

#### **POWER GOOD FLAG**

The XRP6274 features a Power Good Flag output signaling an abnormal operating condition. A low voltage on the Power Good Flag output indicates:

- Output voltage  $V_{\text{OUT}}$  is approximately 9% below its expected value
- A thermal fault has occurred

The Power Good Flag output, is an open collector capable of sinking in excess of 1mA.

#### **OUTPUT CURRENT LIMIT PROTECTION**

The XRP6274 integrates output current limit protection in order to protect the system main power supply, the regulator itself and the load from excessive current flow. This current limit

effectively keeps the flow of current in the circuit at a safe level.

In short circuit conditions, the device will take additional steps to limit input and power by disabling and re-enabling the pass device until the short condition is removed and normal operation can resume. Depending on the impedance of the short, this short circuit protection function may initiate operation between 10% and 50% of the targeted output voltage

#### THERMAL PROTECTION AND SHUTDOWN

The XRP6274 includes a thermal shutdown circuitry in order to restrict the device's operating temperature within a safe operating range. When activated, typically at 160°C, the XRP6274 is forced into a low power reset state with a typical hysteresis of 30 degrees.

Combined with the short circuit current protection, it reduces and limits the heating effects of over-temperature and/or over-current conditions on the LDO and surrounding circuits.

#### **REVERSE BIAS PROTECTION**

In addition to the standard protection features in these devices, they also incorporate a reverse bias protection. Most LDOs have a parasitic body diode that provides a path from  $V_{\text{OUT}}$  to  $V_{\text{IN}}$  if the input is shorted to ground. The XRP6274 has a blocking diode to ensure that no high discharge currents can occur between the output and the input when the input is shorted to ground.

## **TYPICAL APPLICATION CIRCUIT**

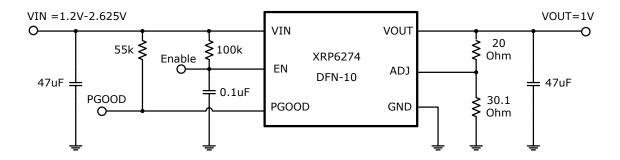
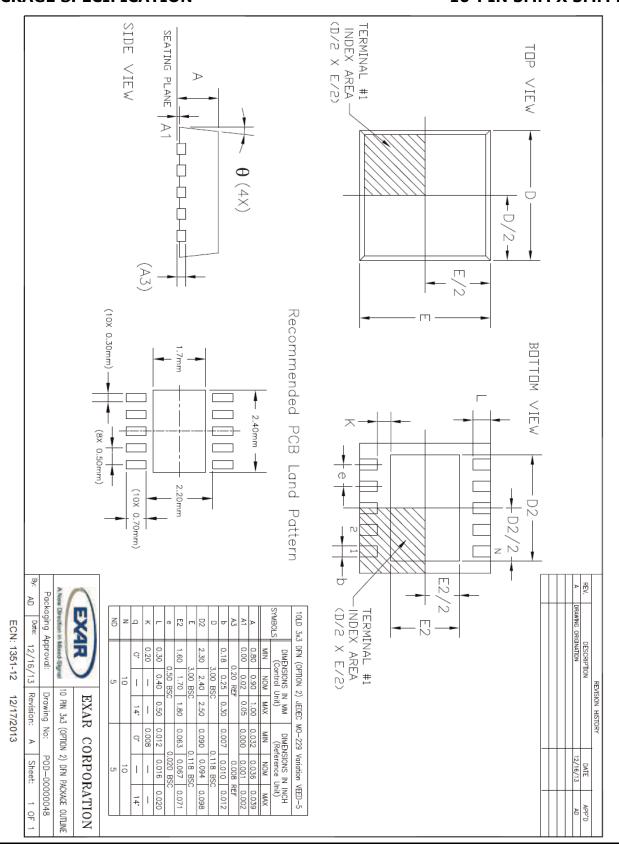


Fig. 14: XRP6274 Typical Application Diagram



## **PACKAGE SPECIFICATION**

## 10-PIN 3MM X 3MM DFN





#### **REVISION HISTORY**

| Revision | Date       | Description   |  |  |  |  |  |  |
|----------|------------|---|--|--|--|--|--|--|
| 1.0.0    | 12/26/2013 | Initial release. [ECN: 1352-07]                     |  |  |  |  |  |  |
| 1.0.0    | 01/07/2013 | Typographical and formatting changes [ECN: 1402-XX] |  |  |  |  |  |  |
|          |            |   |  |  |  |  |  |  |
|          |            |   |  |  |  |  |  |  |

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